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Product data sheet

1. Product profile

1.1 General description

The device is designed to protect high-speed interfaces such as High-Definition Multimedia Interface (HDMI), DisplayPort, USB, external Serial Advanced Technology Attachment (eSATA) and Low Voltage Differential Signaling (LVDS) interfaces against ElectroStatic Discharge (ESD).

The device includes high-level ESD protection diodes for high-speed signal lines in an ultra small and leadless plastic package DFN2110-9 (SOT1178-1/XSON9). The extremely small package dimensions (2.1 mm \times 1 mm \times 0.5 mm) make this product ideally suitable for portable devices. The pinout is designed for convenient flow-through routing of high-speed signal lines.

All signal lines are protected by a special diode configuration offering ultra low line capacitance of 0.85 pF maximum. These diodes provide protection to downstream components from ESD voltages up to ± 12 kV contact according to IEC 61000-4-2, level 4.

1.2 Features and benefits

- System ESD protection for USB 2.0, HDMI 1.3 and HDMI 1.4, DisplayPort, eSATA and LVDS
- All signal lines with integrated rail-to-rail clamping diodes for downstream ESD protection of ±12 kV according to IEC 61000-4-2, level 4
- Matched 0.4 mm pitch trace spacing
- Line capacitance of 0.85 pF maximum for each channel
- Design-friendly 'flow-through' signal routing

1.3 Applications

The device is designed for high-speed receiver and transmitter port protection:

- Portable devices
- Mobile handsets
- TVs, monitors
- DVD recorders and players
- Notebooks, mother boards, graphic cards and ports
- Set-top boxes and game consoles



2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	ESD protection		4 0 4 5
2	ESD protection		1 2 4 5
3	ground	1 2 4 5	
4	ESD protection	Transparent top view	
5	ESD protection		本本 本本
6	not connected		3
7	not connected		018aaa116
8	not connected		
9	not connected		

3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
IP4285CZ9-TBB		ultra small and leadless plastic package; 9 terminals; body $2.1 \times 1 \times 0.5$ mm	SOT1178-1

4. Marking

Table 3. Marking codes

Type number	Marking code
IP4285CZ9-TBB	85

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{I}	input voltage		-0.5	+5.5	V
V _{ESD}	electrostatic discharge voltage	pins 1, 2, 4, 5 to ground; IEC 61000-4-2, level 4; contact discharge	-	±12	kV
T _{amb}	ambient temperature		-40	+85	°C
T _{stg}	storage temperature		-55	+125	°C

6. Characteristics

Table 5. Characteristics

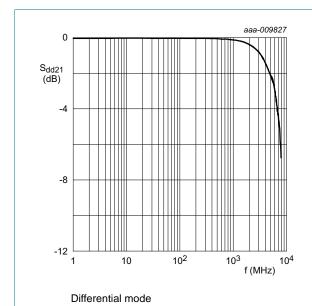
 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{BR}	breakdown voltage	I _{test} = 1 mA	6	-	9	V
I _{RM}	reverse leakage current	per channel; V _I = 5.0 V	-	-	1	μА
V _F	forward voltage		-	0.7	-	V
C _{line}	line capacitance	f = 1 MHz [1]				
		V _{bias} = 0 V	-	-	0.85	pF
		V _{bias} = 2.5 V	-	-	0.75	pF
ΔC_{line}	line capacitance difference	f = 1 MHz; V _{bias} = 2.5 V	-	-	0.1	pF
r _{dyn}	dynamic resistance	TLP [2]				
		positive transient	-	0.42	-	Ω
		negative transient	-	0.33	-	Ω
		surge [3]				
		positive transient	-	0.42	-	Ω
		negative transient	-	0.33	-	Ω
V _{CL}	clamping voltage	I _{PP} = 4 A [3]				
		positive transient	-	3.9	-	V
		negative transient	-	-2.3	-	V

^[1] This parameter is guaranteed by design.

^{[2] 100} ns Transmission Line Pulse (TLP); 50 Ω ; pulser at 80 ns.

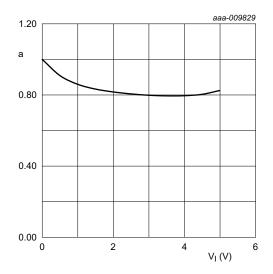
^[3] According to IEC 61000-4-5.



-80 10 10² 10³ 10⁴

Fig 1. Insertion loss, typical values

Fig 2. Crosstalk response curves, typical values



$$a = \frac{C_{line(TMDS)}}{C_{line(TMDS)(V_I)}}$$

Fig 3. Relative channel capacitance as a function of bias voltage, typical values

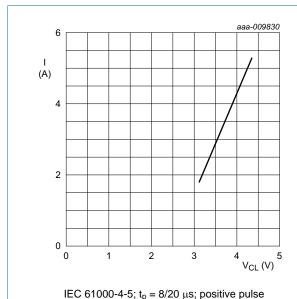
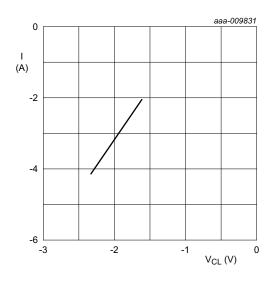


Fig 4. Dynamic resistance with positive clamping



IEC 61000-4-5; $t_p = 8/20 \mu s$; negative pulse

Fig 5. Dynamic resistance with negative clamping

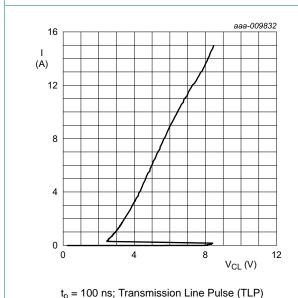
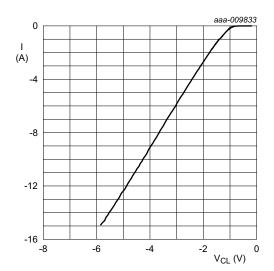


Fig 6. Dynamic resistance with positive clamping



 t_p = 100 ns; Transmission Line Pulse (TLP)

Fig 7. Dynamic resistance with negative clamping

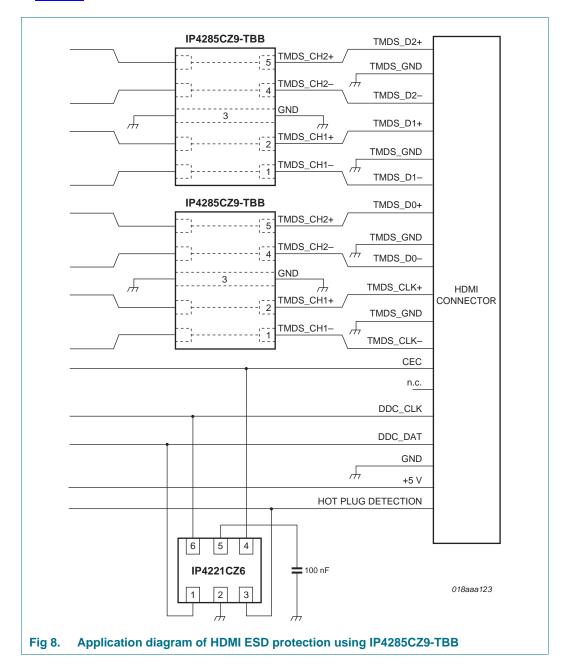
The device uses an advanced clamping structure, which shows a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).

7. Application information

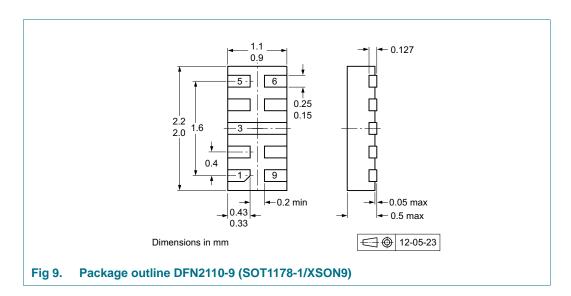
The device is designed to provide high-level ESD protection for high-speed serial data buses such as HDMI, DisplayPort, eSATA and LVDS data lines.

When designing the Printed-Circuit Board (PCB), careful consideration should be given to basic high-speed routing guidelines, impedance matching, and signal coupling. Signal pins 1 and 2 (4 and 5) can be laid out through not connected pins 9 and 8 (6 and 7) respectively to avoid the need for vias and stubs.

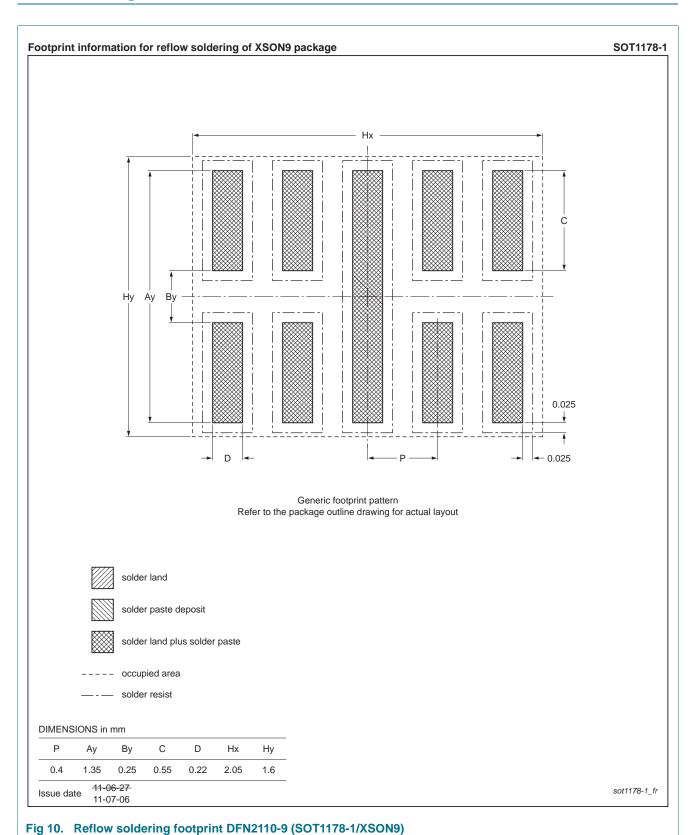
Basic application diagrams for the ESD protection of an HDMI interface are shown in Figure 8.



8. Package outline



9. Soldering



IP4285CZ9-TBB

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10. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
IP4285CZ9-TBB v.3	20140407	Product data sheet	-	IP4285CZ9-TBB v.2
Modifications:	Measurement	s updated after silicon manufa	cturing transfer	
IP4285CZ9-TBB v.2	20120712	Product data sheet		IP4285CZ9-TBB v.1
IP4285CZ9-TBB v.1	20110527	Product data sheet	-	-

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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